

U.S. Department of Commerce Patent and Trademark Office				ATTY DOCKET NO. BMID 9958 CIP US	SERIAL NO. 10/601,144		
				APPLICANT BHULLAR et al.			
INFORMATION DISCLOSURE STATEMENT				FILING DATE 06/20/2003	GROUP 1243 3200		
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date
CPA	49	5,965,001	10-12-99	Chow et al.	204	600	
CPA	50	6,004,441	12-21-99	Fujiwara et al.	204	412	
CPA	51	6,103,033	8-15-00	Say et al.	156	73.1	
CPA	52	6,134,461	10-17-00	Say et al.	600	345	
CPA	53	6,165,594	12-26-00	Moh et al.	428	207	
CPA	54	6,175,752 B1	1-16-01	Say et al.	600	345	
CPA	55	6,203,952 B1	3-20-01	O'Brien et al.	430	17	
CPA	56	6,258,229 B1	7-01	Winarta et al.	205	403	
CPA	57	6,287,451 B1	9-11-01	Winarta et al.	205	777.5	
CPA	58	6,299,757 B1	10-9-01	Feldman et al.	205	775	
CPA	59	6,309,526 B1	10-30-01	Fujiwara et al.	204	403	
CPA	60	6,338,790 B1	1-15-02	Feldman et al.	205	777.5	
CPA	61	6,399,258 B2	6-4-02	O'Brien et al.	430	17	
CPA	61b	6,662,439	12-16-03	Bhullar	29	825	
CPA	62	6,696,008 B2	2-24-04	Bradinger	264	400	5-25-01
CPA	63	US 2001/0006766 A1	7-5-01	O'Brien et al.			1-12-01
CPA	64	US 2003/0088166 A1	5-8-2003	Say et al.			11-11-2002
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		Document Number	Date	Country	Class	Subclass	Translation Yes No
CPA	65	0 480 703 A2	4/92	EP			--
CPA	66	0 480 703 B1	3/97	EP			--
CPA	67	0 875 754	11-4-98	EP			--
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CPA	70	1 202 060 A1	5-2-2002	EP			--
CPA	71	1 203 956 A2/A3	5-8-2002	EP			--
CPA	72	1 288 654 A1	03-05-03	EP			--
CPA	74	2000-121594 abstract	April 00	JP			--
CPA	75	56100451	Aug 81	JP			yes (abstract)
CPA	76	11297890	Oct. 99	JP			yes (abstract)
CPA	77	7-66499	3-10-95	JP			yes (abstract)
CPA	78	7-290751	11-7-95	JP			yes (abstract)
CPA	79	9-260697	10-3-97	JP			yes (abstract)
CPA	80	10-241992 abstract	9-1-98	JP			yes (abstract)
CPA	81	10-303444 abstract	11-1-98	JP			--
CPA	83	10-275959	10-1-98	JP			yes (abstract)
CPA	84	5-31 5703	11-26-93	JP			yes (abstract)
CPA	85	10-52780 abstract	2-24-98	JP			--
Examiner	c.g. Arles			Date Considered	16/11/05		

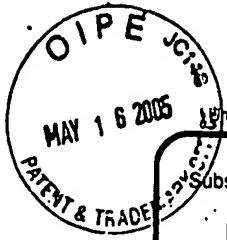
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INFORMATION DISCLOSURE STATEMENT					FOREIGN PATENT DOCUMENTS	
1	86	WO 91/02391	2-21-91	PCT	—	—
2	87	WO 91/08474	6-13-91	PCT	—	—
3	88	WO 95/22881	8-24-95	PCT	—	—
4	89	WO 98/35225	8-13-98	PCT	—	—
5	90	WO 98/49773	Dec 98	PCT	—	—
6	91	WO 99/13101	3-18-99	PCT	—	—
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11	96	WO 00/73778	12/2000	PCT	—	—
12	97	WO 00/73785	12/2000	PCT	—	—
13	98	WO 01/36953	5-25-01	PCT	—	yes abstract
14	99	WO 01/75438	10-11-01	PCT	—	—
15	100	WO 01/25775	4-12-01	PCT	—	—
16	101	WO 01/92884	12-6-01	PCT	—	yes abstract
17	102	WO 02/086483	10-31-02	PCT	—	yes abstract
18	103	WO 02/27074	4-4-02	PCT	—	yes abstract
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*Examiner Initial	105	Tender, L. et al., "Electrochemical Patterning of Self-Assembled Monolayers onto Microscopic Arrays of Gold Electrodes Fabricated by Laser Ablation, <i>Langmuir</i> , 1996, 12, 5515-5518.				
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CPA	111	Vaucher et al. "Laser Direct Imaging and Structuring: An Update", <a href="http://www.circuitree.com/CDA/ArticleInformation/features/BNP_Features_Item/0.2133.81173.00.html">http://www.circuitree.com/CDA/ArticleInformation/features/BNP_Features_Item/0.2133.81173.00.html</a> ; posted on: 08/01/2002.				
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CPA	115	Duley, W.W. "UV Lasers: effects and applications in materials science", Chapter 3 Photochemical and photothermal effects, Cambridge University Press, pages 78-97.				
Examiner	C. J. Curley			Date Considered	10/6/05	
U.S. Department of Commerce			ATTY DOCKET NO. BMID 9958 CIP US	SERIAL NO. 10/601,144		

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## **INFORMATION DISCLOSURE STATEMENT BY APPLICANT**

*(use as many sheets as necessary)*

Sheet 1 of 1 Attorney Docket Number BMID 9958 CIP

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## U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No. <sup>1</sup>	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Application of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T <sup>4</sup>
		Country Code <sup>3</sup> -Number <sup>4</sup> -Kind Code <sup>5</sup> (if known)				
04	1	JP 189675 (abstract)	1997-04-22	Matsushita Electric Ind Col Ltd..		X

Examiner Signature	<i>C. J. Abel</i>	Date Considered	4/17/05
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